



DMN2230U

N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
 - $110m\Omega @ V_{GS} = 4.5V$
 - 145mΩ @ VGS = 2.5V
 - 230mΩ @ VGS = 1.8V
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (DMN2230UQ)

Mechanical Data

- Package: SOT23 •
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.008 grams (Approximate)

SOT23

Top View

Ordering Information (Note 4)

Part Number	Paskaga	Pac	Packing			
Part Number	Package	Qty.	Carrier			
DMN2230U-7	SOT23	3,000	Tape & Reel			

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. Notes:

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

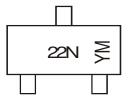
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Top View Internal Schematic

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

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Marking Information



22N = Product Type Marking Code YM = Date Code Marking Y = Year (ex: K = 2023)

M = Month (ex: 1 = January)

Data Coda Kay

Year	2007		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	U		K	L	М	N	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Drain-Source Voltage	VDSS	20	V
Gate-Source Voltage	V _{GSS}	±12	V
Drain Current (Note 5)	lD	2.0	А
Pulsed Drain Current (Note 6)	I _{DM}	7	A

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	600	mW
Thermal Resistance, Junction to Ambient	Reja	208	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C
			-

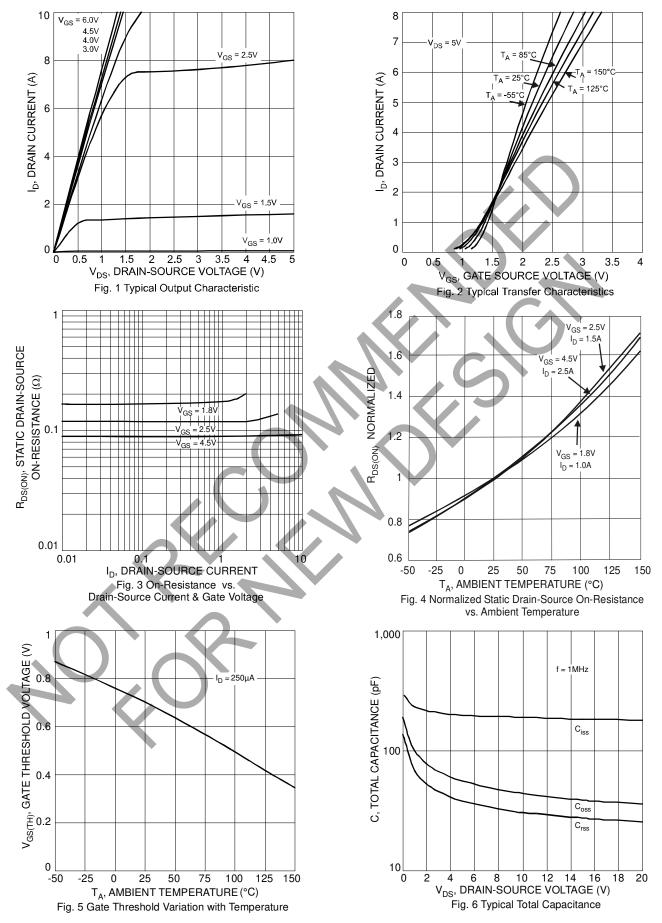
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	20	—		V	V _{GS} = 0V, I _D = 10μA
Zero Gate Voltage Drain Current	IDSS	-		1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	lgss		ſ	±10	μA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	0.5	_	1.0	V	$V_{DS} = V_{CS}, I_D = 250 \mu A$
			81	110		VGS = 4.5V, ID = 2.5A
Static Drain-Source On-Resistance	RDS(ON)	_	113	145	mΩ	VGS = 2.5V, ID = 1.5A
			170	230		VGS = 1.8V, ID = 1.0A
Forward Transfer Admittance	Yfs	1	5		S	V _{DS} = 5V, I _D = 2.4A
Diode Forward Voltage (Note 7)	Vsd		0.8	1.1	V	VGS = 0V, IS = 1.05A
DYNAMIC CHARACTERISTICS						
Input Capacitance	Ciss		188		pF	
Output Capacitance	Coss		44		pF	Vps = 10V, Vgs = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		30	_	pF	1 = 1.000112
Total Gate Charge	Qg		2.3		nC	
Gate-Source Charge	Qgs		0.3	_	nC	V _{DS} = 10V, I _D = 11.6A
Gate-Drain Charge	Q _{gd}	_	0.5	_	nC	
Turn-On Delay Time	td(on)	_	8	-		
Rise Time	tr		3.8		ns	$V_{DD} = 10V, R_L = 10\Omega,$
Turn-Off Delay Time	t _{d(off)}		19.6		115	$I_D = 1A$, $V_{GEN} = 4.5V$, $R_G = 6\Omega$
Fall Time	tr		8.3	_		

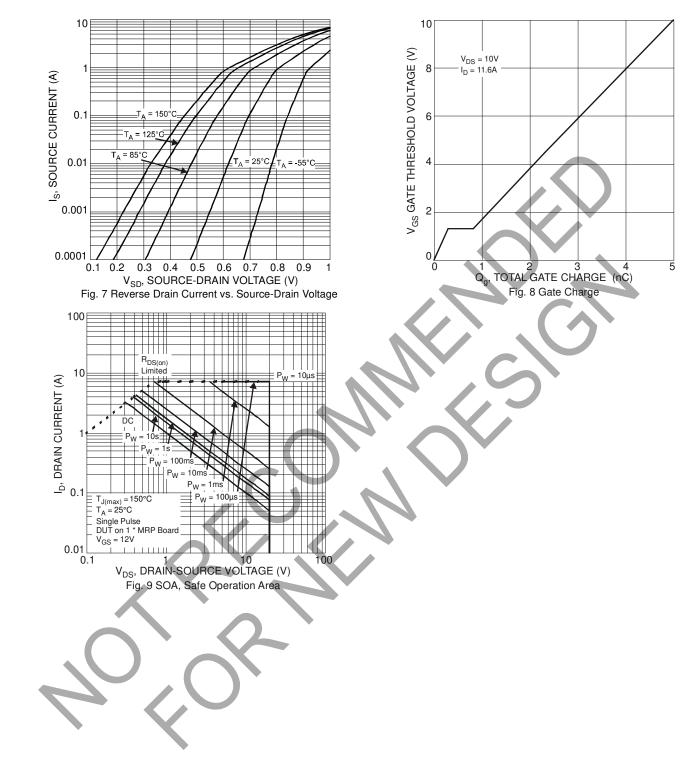
 Device mounted on FR-4 PCB, or minimum recommended pad layout.
Repetitive rating, pulse width limited by junction temperature.
Short duration pulse test used to minimize self-heating effect. Notes:



DMN2230U



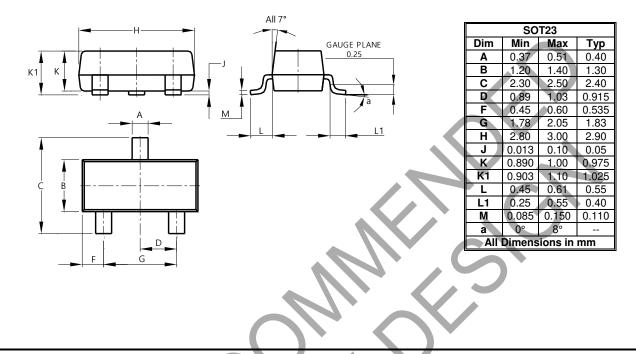






Package Outline Dimensions

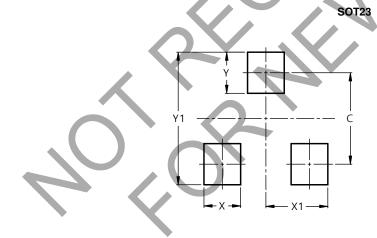
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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